# **Very Low Phase Noise Synthesiser Divider**

DS3739 - 2.1 April 1994

The SP8400 is a very low phase noise programmable divider which is based on a divide by 8/9 dual modulus prescaler and a 12 stage control counter. This gives a minimum division ratio of 56 (64 for fractional - N synthesis applications), and a maximum division ratio of 4103. Special circuit techniques have been used to reduce the phase noise considerably below that produced by standard dividers. The data inputs are CMOS or TTL compatible.

The SP8400 is packaged in a 28 pin plastic SO package.

#### **FEATURES**

- Very low Phase Noise (Typically -156dBc/Hz at 1kHz offset)
- Supply Voltage 5V

#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage 6.5V
Output Current 20mA
Storage Temperature Range -55°C to +125°C
Maximum Clock Input Voltage 2.5V p-p

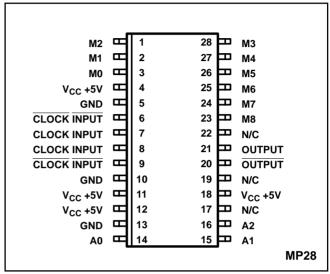


Fig.1 Pin connections - top view

#### **ORDERING INFORMATION**

SP8400 KG MPES(Commercial Grade)

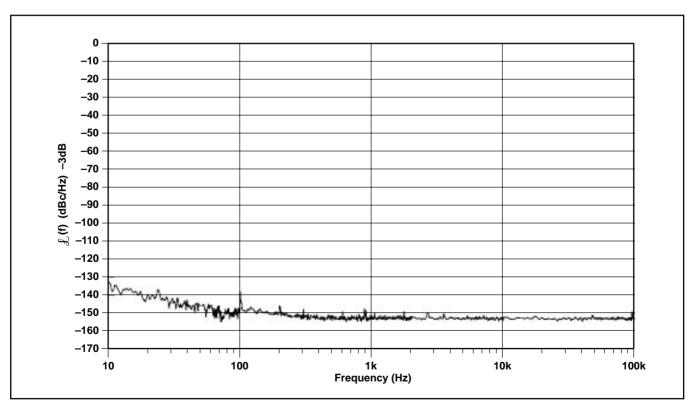


Fig.2 Typical single sideband phase noise measured at 300MHz

### **ELECTRICAL CHARACTERISTICS**

Guaranteed over: Supply voltage  $V_{CC}$  = +4.75V to +5.25V Temperature  $T_{amb}$  = -10°C to +75°C Tested at +4.75V and +5.25V at  $T_{amb}$  = +25°C

Characteristic	Pin	Value			Units	Conditions	
Onaracteristic	r III	Min.	Тур.	Max.		Conditions	
Supply current Output voltage swing Input sensitivity 200MHz to 1.5GHz	4, 11, 12, 18 20, 21 7, 8	122 320	137 410	152 140 (-4)	mA mV mV dBm	Output loaded with 300R See Fig.4 p-p @ 1.5GHz input ÷ 71 mode See Fig.4 RMS Sine wave into 50 Ohms (dBm equivalent) See Fig.3	
Data Inputs Logic high voltage Low low voltage Input current		2.2		0.8 180	V V μΑ	5V Data input voltage	

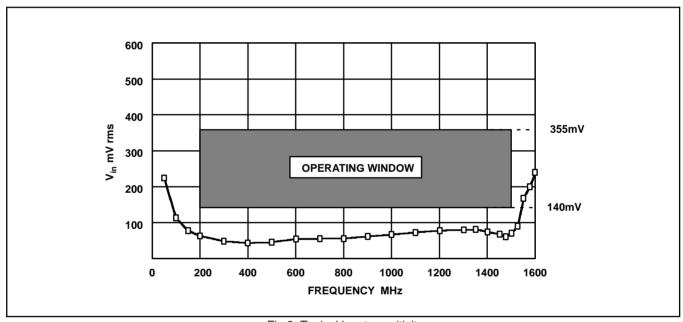


Fig.3 Typical input sensitivity

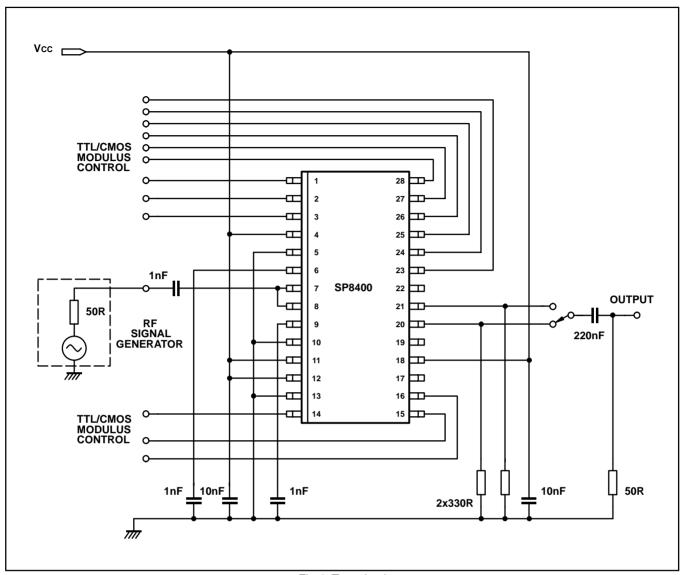


Fig.4 Test circuit

### **APPLICATIONS INFORMATION**

#### Circuit description, synthesiser divider

The divider is based on a divide by 8/9 modulus prescaler, and a 12 stage control counter. This gives minimum fractional – N division ratio of 64 (56 for general division), and a maximum division ratio of 4103. The inputs to the control counter are TTL/CMOS compatible. There is a fixed offset of 8 between the number on the data lines and the actual division ratio.

The output is one transition only per divide cycle. This eliminates the problem of where to put the redundant edge when the divider is used in a fractional–N system, and also avoids the problem of how to define the output pulse width. This means that the overall division ratio conventionally defined in terms of the rate of edges of the same polarity is twice the selected division ratio.

### **Equations for division**

The M and A data inputs form a 12 bit number with A0 being the least significant bit and M8 being the most significant bit

Definition 1: Division ratio – (input frequency to output edges, positive or negative).

= Number loaded + 8

Definition 2: Division ratio – (input frequency to output frequency).

= (Number loaded + 8) x 2

### Available division ratio

All division ratios of 64 to 4103 (Definition 1) will return the divider to the same internal state at the end of the count and hence these are the only divisional ratios to be used for fractional–N synthesiser application.

All division ratios of 56 to 4103 are available for general division purposes. Additional division ratios available for general division are:-

8,9 16, 17, 18 24, 25, 26, 27 32, 33, 34, 35, 36 40, 41, 42, 43, 44, 45 48, 49, 50, 51, 52, 53, 54

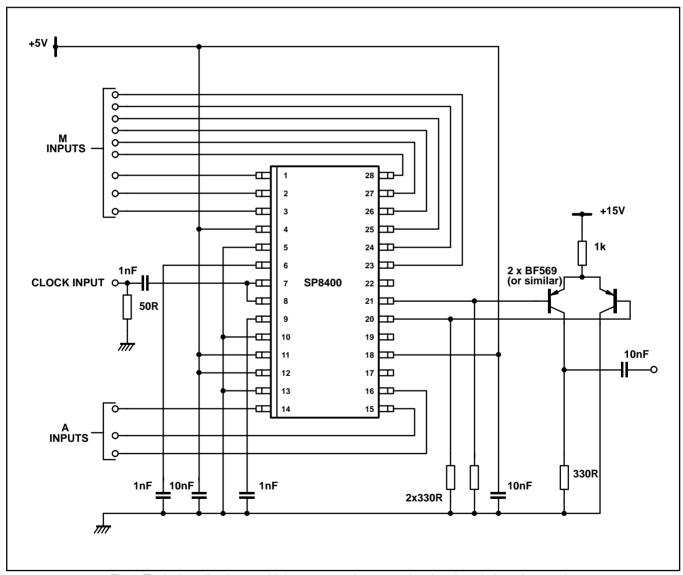
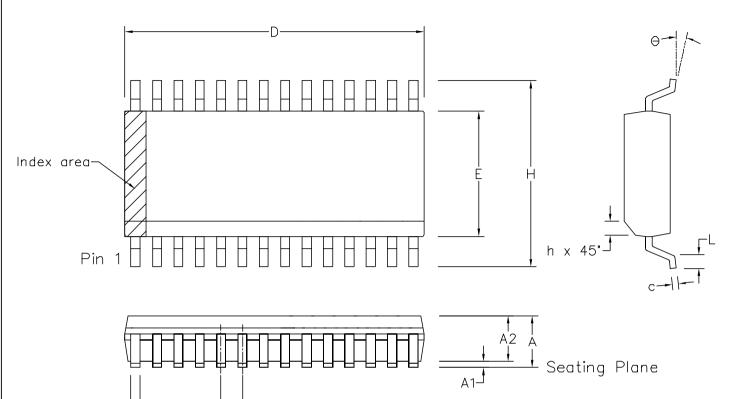


Fig.5 Typical application combining output to increase signal and retain low phase noise



	Control Dimensions				Altern. Dimensions			
Symbol	in	millimet	res		in inches			
'	MIN	Nominal	MAX		MIN	Nominal	MAX	
Α	2.35		2.65		0.093		0.104	
A1	0.10		0.30		0.004		0.012	
A2	2.25		2.35		0.089		0.092	
D	17.70		18.10		0.697		0.713	
Н	10.00		10.65		0.394		0.419	
E	7.40		7.60		0.291		0.299	
L	0.40		1.27		0.016		0.050	
е	1	.27 BS0	).		0.050 BSC.			
b	0.33		0.51		0.013		0.020	
С	0.23		0.32		0.009		0.013	
$\Theta$	0°		8°		0°		8°	
h	0.25		0.75		0.010		0.029	
	Pin features							
N	28							
Cor	Conforms to JEDEC MS-013AE Iss. C							

## Notes:

- 1. The chamfer on the body is optional. If it not present, a visual index feature, e.g. a dot, must be located within the cross—hatched area.
- 2. Controlling dimension are in millimeters.

- 3. Dimension D do not include mould flash, protusion or gate burrs. These shall not exceed 0.006" per side.
  4. Dimension E1 do not include inter—lead flash or protusion. These shall not exceed 0.010" per side.
  5. Dimension b does not include dambar protusion/intrusion. Allowable dambar protusion shall be 0.004" total in excess of b dimension.

(C) Mitel				ORIGINATING SITE: SWINDON			
ISSUE	1	2				SEMICONDUCTOR	Title: Package Outline Drawing for 28 Ids SOIC(W)-0.300" Body Width (MP)
ACN	006746	201943					
DATE	7APR95	27FEB97					Drawing Number
APPROVED							GPD00017



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